

# Power Transistor 80 V, 8 A General Purpose NPN

# **MJK44H11**

Designed for general purpose power and switching applications such as regulators, converters and power amplifiers. Housed in advanced LFPAK package (5 x 6 mm) with excellent thermal conduction. Automotive end applications include air bag deployment, power train control units, and instrument clusters.

#### **Features**

- Complementary NPN: MJK45H11
- NJV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

### **MAXIMUM RATINGS** $(T_A = 25^{\circ}C)$

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CEO}$	80	Vdc
Emitter-Base Voltage	V <sub>EBO</sub>	5	Vdc
Collector Current - Continuous	I <sub>C</sub>	8	Α
Collector Current – Peak	I <sub>CM</sub>	16	Α
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL CHARACTERISTICS

Characteristics	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient per Device (Note 1)	$R_{\theta JC}$	6	°C/W
Thermal Resistance, Junction-to-Ambient per Device (Note 1)	$R_{\theta JA}$	70	°C/W
Total Power Dissipation per Device @ T <sub>A</sub> = 25°C (Note 1)	P <sub>D</sub>	20	W

1

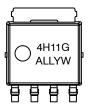
# NPN TRANSISTOR 80 V, 8 A





LFPAK4 5x6 CASE 760AB

#### MARKING DIAGRAM



4H11G = Specific Device Code A = Assembly Location

 LL
 = Wafer Lot

 Y
 = Year

 W
 = Work Week

## **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MJK44H11TWG	LFPAK4 5x6 (Pb-Free)	3000 / Tape & Reel
NJVMJK44H11TWG	LFPAK4 5x6 (Pb-Free)	3000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

<sup>1.</sup> Surface-mounted on FR4 board using a 1in<sup>2</sup>, 2 oz. Cu pad

# $\textbf{ELECTRICAL CHARACTERISTICS} \ (T_A = 25^{\circ}C \ unless \ otherwise \ noted)$

Characteristic	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS	OFF CHARACTERISTICS					
Collector–Emitter Sustaining Voltage ( $I_C = 30 \text{ mA}, I_B = 0$ )	V <sub>CEO(sus)</sub>	80	-	_	Vdc	
Collector Cutoff Current $(V_{CE} = Rated V_{CEO}, V_{BE} = 0)$	I <sub>CES</sub>	_	-	1.0	μΑ	
Emitter Cutoff Current (V <sub>EB</sub> = 5 Vdc)	I <sub>EBO</sub>	_	-	1.0	μΑ	
ON CHARACTERISTICS	ON CHARACTERISTICS					
Collector-Emitter Saturation Voltage (I <sub>C</sub> = 8 Adc, I <sub>B</sub> = 0.4 Adc)	V <sub>CE(sat)</sub>	-	-	1.0	Vdc	
Base-Emitter Saturation Voltage $(I_C = 8 \text{ Adc}, I_B = 0.8 \text{ Adc})$	V <sub>BE(sat)</sub>	-	-	1.5	Vdc	
DC Current Gain $(V_{CE} = 1 \text{ Vdc}, I_C = 2 \text{ Adc})$ $(V_{CE} = 1 \text{ Vdc}, I_C = 4 \text{ Adc})$	h <sub>FE</sub>	60 40	- -	- -	-	
DYNAMIC CHARACTERISTICS						
Collector Capacitance (V <sub>CB</sub> = 10 Vdc, f <sub>test</sub> = 1 MHz)	C <sub>cb</sub>	-	-	45	pF	
Gain Bandwidth Product (I <sub>C</sub> = 0.5 Adc, V <sub>CE</sub> = 10 Vdc, f = 20 MHz)	f <sub>T</sub>	-	85	-	MHz	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

## **TYPICAL CHARACTERISTICS**

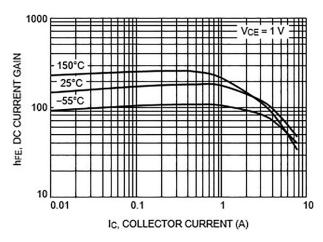


Figure 1. DC Current Gain

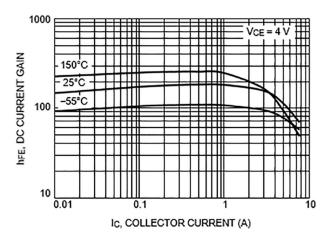


Figure 2. DC Current Gain

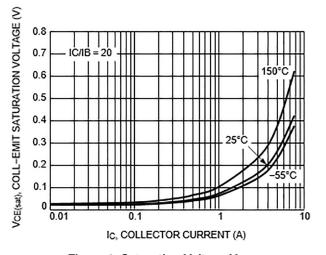


Figure 3. Saturation Voltage V<sub>CE(sat)</sub>

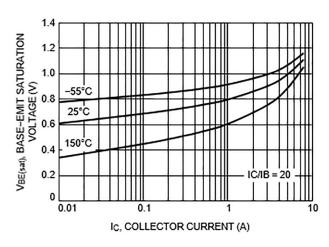


Figure 4. Saturation Voltage V<sub>BE(sat)</sub>

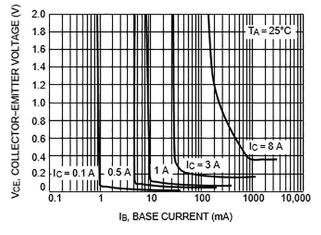


Figure 5. Collector Saturation Region

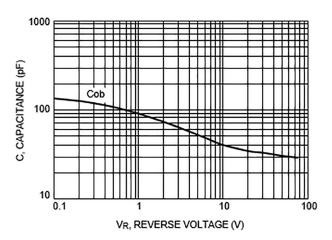
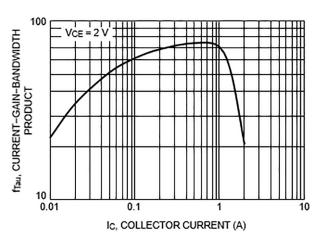


Figure 6. Capacitance

## TYPICAL CHARACTERISTICS (CONTINUED)



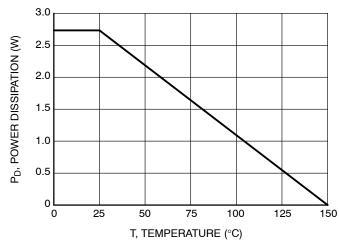


Figure 7. Current-Gain-Bandwidth Product

Figure 8. Power Derating

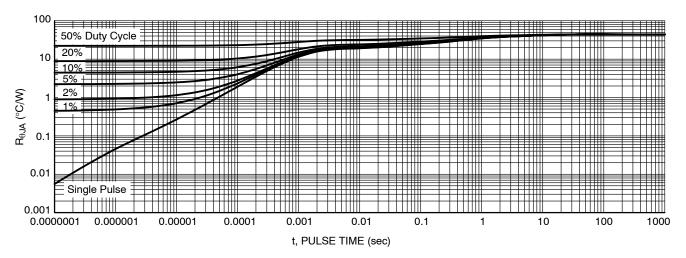
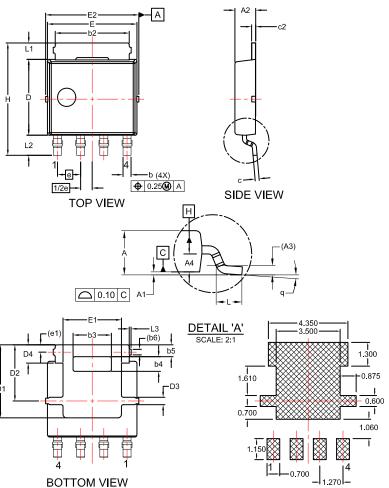


Figure 9. Typical Transient Thermal Response, Junction-to-Case

#### PACKAGE DIMENSIONS

## LFPAK4 5x6 CASE 760AB ISSUE C



## RECOMMENDED LAND PATTERN

\*FOR ADDITIONAL INFORMATION ON OUR PB-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRMD.

#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR BURRS. MOLD FLASH PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.150mm PER SIDE.
- 4. DIMENSIONS D AND E ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
- 5. DATUMS A AND B ARE DETERMINED AT DATUM PLANE H.

UNIT IN MILLIMETER			
DIM	MIN	NOM	MAX
Α	1.10	1.20	1.30
A1	0.00	0.08	0.15
A2	1.10	1.15	1.20
A3	(	).25 REF	=
A4	0.45	0.50	0.55
b	0.40	0.45	0.50
b2	3.80	4.10	4.40
b3	2.00	2.10	2.20
b4	0.70	0.80	0.90
b5	0.55	0.65	0.75
b6	0.31 REF		
С	0.19	0.22	0.25
c2	0.19	0.22	0.25
D	4.05	4.15	4.25
D1	3.80	4.00	4.20
D2	3.00	3.10	3.20
D3	0.30	0.40	0.50
D4	0.90	1.00	1.10
Е	4.80	4.90	5.00
E1	3.10	3.20	3.30
E2	5.00	5.15	5.30
е	1,27 BSC		
1/2e	0.635 BSC		
e1	0.40 REF		
Н	6.00	6.15	6.30
L	0.40	0.65	0.85
L1	0.80	0.90	1.00
L2	0.90	1.10	1.30
L3	0.00	0.10	0.20
q	0°	4°	8°

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